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### Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### **Applications of Embedded - FPGAs**

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

#### **Details**

Product Status	Obsolete
Number of LABs/CLBs	3747
Number of Logic Elements/Cells	89178
Total RAM Bits	6839296
Number of I/O	260
Number of Gates	-
Voltage - Supply	0.87V ~ 0.93V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	572-BGA, FCBGA
Supplier Device Package	572-FBGA, FC (25x25)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/intel/ep2agx95df25c5n">https://www.e-xfl.com/product-detail/intel/ep2agx95df25c5n</a>

**Table 1–3. Maximum Allowed Overshoot During Transitions for Arria II Devices**

<b>Symbol</b>	<b>Description</b>	<b>Condition (V)</b>	<b>Overshoot Duration as % of High Time</b>	<b>Unit</b>
V <sub>I</sub> (AC)	AC Input Voltage	4.0	100.000	%
		4.05	79.330	%
		4.1	46.270	%
		4.15	27.030	%
		4.2	15.800	%
		4.25	9.240	%
		4.3	5.410	%
		4.35	3.160	%
		4.4	1.850	%
		4.45	1.080	%
		4.5	0.630	%
		4.55	0.370	%
		4.6	0.220	%

### Maximum Allowed I/O Operating Frequency

Table 1–4 lists the maximum allowed I/O operating frequency for Arria II GX I/Os using the specified I/O standards to ensure device reliability.

**Table 1–4. Maximum Allowed I/O Operating Frequency for Arria II GX Devices**

<b>I/O Standard</b>	<b>I/O Frequency (MHz)</b>
HSTL-18 and HSTL-15	333
SSTL -15	400
SSTL-18	333
2.5-V LVCMOS	260
3.3-V and 3.0-V LVTTL	250
3.3-V, 3.0-V, 1.8-V, and 1.5-V LVCMOS	
PCI and PCI-X	
SSTL-2	200
1.2-V LVCMOS HSTL-12	

## Recommended Operating Conditions

This section lists the functional operation limits for AC and DC parameters for Arria II GX and GZ devices. All supplies are required to monotonically reach their full-rail values without plateaus within  $t_{RAMP}$ .

Table 1–5 lists the recommended operating conditions for Arria II GX devices.

**Table 1–5. Recommended Operating Conditions for Arria II GX Devices (Note 1) (Part 1 of 2)**

Symbol	Description	Condition	Minimum	Typical	Maximum	Unit
$V_{CC}$	Supplies power to the core, periphery, I/O registers, PCIe HIP block, and transceiver PCS	—	0.87	0.90	0.93	V
$V_{CCCB}$	Supplies power to the configuration RAM bits	—	1.425	1.50	1.575	V
$V_{CCBAT}$ (2)	Battery back-up power supply for design security volatile key registers	—	1.2	—	3.3	V
$V_{CCPD}$ (3)	Supplies power to the I/O pre-drivers, differential input buffers, and MSEL circuitry	—	3.135	3.3	3.465	V
		—	2.85	3.0	3.15	V
		—	2.375	2.5	2.625	V
$V_{CCIO}$	Supplies power to the I/O banks (4)	—	3.135	3.3	3.465	V
		—	2.85	3.0	3.15	V
		—	2.375	2.5	2.625	V
		—	1.71	1.8	1.89	V
		—	1.425	1.5	1.575	V
		—	1.14	1.2	1.26	V
$V_{CCD\_PLL}$	Supplies power to the digital portions of the PLL	—	0.87	0.90	0.93	V
$V_{CCA\_PLL}$	Supplies power to the analog portions of the PLL and device-wide power management circuitry	—	2.375	2.5	2.625	V
$V_I$	DC Input voltage	—	-0.5	—	3.6	V
$V_O$	Output voltage	—	0	—	$V_{CCIO}$	V
$V_{CCA}$	Supplies power to the transceiver PMA regulator	—	2.375	2.5	2.625	V
$V_{CCL\_GXB}$	Supplies power to the transceiver PMA TX, PMA RX, and clocking	—	1.045	1.1	1.155	V
$V_{CCH\_GXB}$	Supplies power to the transceiver PMA output (TX) buffer	—	1.425	1.5	1.575	V
$T_J$	Operating junction temperature	Commercial	0	—	85	°C
		Industrial	-40	—	100	°C

## I/O Pin Leakage Current

Table 1-7 lists the Arria II GX I/O pin leakage current specifications.

**Table 1-7. I/O Pin Leakage Current for Arria II GX Devices**

Symbol	Description	Conditions	Min	Typ	Max	Unit
$I_I$	Input pin	$V_I = 0 \text{ V to } V_{CCIO MAX}$	-10	—	10	$\mu\text{A}$
$I_{OZ}$	Tri-stated I/O pin	$V_O = 0 \text{ V to } V_{CCIO MAX}$	-10	—	10	$\mu\text{A}$

Table 1-8 lists the Arria II GZ I/O pin leakage current specifications.

**Table 1-8. I/O Pin Leakage Current for Arria II GZ Devices**

Symbol	Description	Conditions	Min	Typ	Max	Unit
$I_I$	Input pin	$V_I = 0 \text{ V to } V_{CCIO MAX}$	-20	—	20	$\mu\text{A}$
$I_{OZ}$	Tri-stated I/O pin	$V_O = 0 \text{ V to } V_{CCIO MAX}$	-20	—	20	$\mu\text{A}$

## Bus Hold

Bus hold retains the last valid logic state after the source driving it either enters the high impedance state or is removed. Each I/O pin has an option to enable bus hold in user mode. Bus hold is always disabled in configuration mode.

Table 1-9 lists bus hold specifications for Arria II GX devices.

**Table 1-9. Bus Hold Parameters for Arria II GX Devices (Note 1)**

Parameter	Symbol	Cond.	$V_{CCIO} (\text{V})$												Unit	
			1.2		1.5		1.8		2.5		3.0		3.3			
			Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max		
Bus-hold low, sustaining current	$I_{SUSL}$	$V_{IN} > V_{IL} (\text{max.})$	8	—	12	—	30	—	50	—	70	—	70	—	$\mu\text{A}$	
Bus-hold high, sustaining current	$I_{SUSH}$	$V_{IN} < V_{IL} (\text{min.})$	-8	—	-12	—	-30	—	-50	—	-70	—	-70	—	$\mu\text{A}$	
Bus-hold low, overdrive current	$I_{ODL}$	$0 \text{ V} < V_{IN} < V_{CCIO}$	—	125	—	175	—	200	—	300	—	500	—	500	$\mu\text{A}$	
Bus-hold high, overdrive current	$I_{ODH}$	$0 \text{ V} < V_{IN} < V_{CCIO}$	—	-125	—	-175	—	-200	—	-300	—	-500	—	-500	$\mu\text{A}$	
Bus-hold trip point	$V_{TRIP}$	—	0.3	0.9	0.375	1.125	0.68	1.07	0.7	1.7	0.8	2	0.8	2	V	

### Note to Table 1-9:

- (1) The bus-hold trip points are based on calculated input voltages from the JEDEC standard.

The calibration accuracy for calibrated series and parallel OCTs are applicable at the moment of calibration. When process, voltage, and temperature (PVT) conditions change after calibration, the tolerance may change.

Table 1–13 lists the Arria II GZ OCT without calibration resistance tolerance to PVT changes.

**Table 1–13. OCT Without Calibration Resistance Tolerance Specifications for Arria II GZ Devices**

<b>Symbol</b>	<b>Description</b>	<b>Conditions (V)</b>	<b>Resistance Tolerance</b>		<b>Unit</b>
			<b>C3,I3</b>	<b>C4,I4</b>	
25- $\Omega$ $R_S$ 3.0 and 2.5	25- $\Omega$ internal series OCT without calibration	$V_{CCIO} = 3.0, 2.5$	$\pm 40$	$\pm 40$	%
25- $\Omega$ $R_S$ 1.8 and 1.5	25- $\Omega$ internal series OCT without calibration	$V_{CCIO} = 1.8, 1.5$	$\pm 40$	$\pm 40$	%
25- $\Omega$ $R_S$ 1.2	25- $\Omega$ internal series OCT without calibration	$V_{CCIO} = 1.2$	$\pm 50$	$\pm 50$	%
50- $\Omega$ $R_S$ 3.0 and 2.5	50- $\Omega$ internal series OCT without calibration	$V_{CCIO} = 3.0, 2.5$	$\pm 40$	$\pm 40$	%
50- $\Omega$ $R_S$ 1.8 and 1.5	50- $\Omega$ internal series OCT without calibration	$V_{CCIO} = 1.8, 1.5$	$\pm 40$	$\pm 40$	%
50- $\Omega$ $R_S$ 1.2	50- $\Omega$ internal series OCT without calibration	$V_{CCIO} = 1.2$	$\pm 50$	$\pm 50$	%
100- $\Omega$ $R_D$ 2.5	100- $\Omega$ internal differential OCT	$V_{CCIO} = 2.5$	$\pm 25$	$\pm 25$	%

OCT calibration is automatically performed at power up for OCT-enabled I/Os. When voltage and temperature conditions change after calibration, the resistance may change. Use Equation 1–1 and Table 1–14 to determine the OCT variation when voltage and temperature vary after power-up calibration for Arria II GX and GZ devices.

#### Equation 1–1. OCT Variation (*Note 1*)

$$R_{OCT} = R_{SCAL} \left( 1 + \langle \frac{dR}{dT} \times \Delta T \rangle \pm \langle \frac{dR}{dV} \times \Delta V \rangle \right)$$

##### Notes to Equation 1–1:

- (1)  $R_{OCT}$  value calculated from Equation 1–1 shows the range of OCT resistance with the variation of temperature and  $V_{CCIO}$ .

Use the following with [Equation 1-1](#):

- $R_{SCAL}$  is the OCT resistance value at power up.
- $\Delta T$  is the variation of temperature with respect to the temperature at power up.
- $\Delta V$  is the variation of voltage with respect to the  $V_{CCIO}$  at power up.
- $dR/dT$  is the percentage change of  $R_{SCAL}$  with temperature.
- $dR/dV$  is the percentage change of  $R_{SCAL}$  with voltage.

[Table 1-14](#) lists the OCT variation with temperature and voltage after power-up calibration for Arria II GX devices.

**Table 1-14. OCT Variation after Power-up Calibration for Arria II GX Devices**

Nominal Voltage $V_{CCIO}$ (V)	$dR/dT$ (%/°C)	$dR/dV$ (%/mV)
3.0	0.262	0.035
2.5	0.234	0.039
1.8	0.219	0.086
1.5	0.199	0.136
1.2	0.161	0.288

[Table 1-15](#) lists the OCT variation with temperature and voltage after power-up calibration for Arria II GZ devices.

**Table 1-15. OCT Variation after Power-Up Calibration for Arria II GZ Devices (Note 1)**

Nominal Voltage, $V_{CCIO}$ (V)	$dR/dT$ (%/°C)	$dR/dV$ (%/mV)
3.0	0.189	0.0297
2.5	0.208	0.0344
1.8	0.266	0.0499
1.5	0.273	0.0744
1.2	0.317	0.1241

**Note to Table 1-15:**

(1) Valid for  $V_{CCIO}$  range of  $\pm 5\%$  and temperature range of 0° to 85°C.

### Pin Capacitance

[Table 1-16](#) lists the pin capacitance for Arria II GX devices.

**Table 1-16. Pin Capacitance for Arria II GX Devices**

Symbol	Description	Typical	Unit
$C_{IO}$	Input capacitance on I/O pins, dual-purpose pins (differential I/O, clock, $R_{up}$ , $R_{dn}$ ), and dedicated clock input pins	7	pF

## I/O Standard Specifications

**Table 1–22** through **Table 1–35** list input voltage ( $V_{IH}$  and  $V_{IL}$ ), output voltage ( $V_{OH}$  and  $V_{OL}$ ), and current drive characteristics ( $I_{OH}$  and  $I_{OL}$ ) for various I/O standards supported by the Arria II device family. They also show the Arria II device family I/O standard specifications.  $V_{OL}$  and  $V_{OH}$  values are valid at the corresponding  $I_{OH}$  and  $I_{OL}$ , respectively.



For an explanation of terms used in **Table 1–22** through **Table 1–35**, refer to “[Glossary](#)” on page [1–74](#).

**Table 1–22** lists the single-ended I/O standards for Arria II GX devices.

**Table 1–22. Single-Ended I/O Standards for Arria II GX Devices**

I/O Standard	$V_{CCIO}$ (V)			$V_{IL}$ (V)		$V_{IH}$ (V)		$V_{OL}$ (V)	$V_{OH}$ (V)	$I_{OL}$ (mA)	$I_{OH}$ (mA)
	Min	Typ	Max	Min	Max	Min	Max	Max	Min		
3.3 V LVTTL	3.135	3.3	3.465	-0.3	0.8	1.7	3.6	0.45	2.4	4	-4
3.3 V LVCMOS	3.135	3.3	3.465	-0.3	0.8	1.7	3.6	0.2	$V_{CCIO} - 0.2$	2	-2
3.0 V LVTTL	2.85	3	3.15	-0.3	0.8	1.7	$V_{CCIO} + 0.3$	0.45	2.4	4	-4
3.0 V LVCMOS	2.85	3	3.15	-0.3	0.8	1.7	$V_{CCIO} + 0.3$	0.2	$V_{CCIO} - 0.2$	0.1	-0.1
2.5 V LVCMOS	2.375	2.5	2.625	-0.3	0.7	1.7	$V_{CCIO} + 0.3$	0.4	2	1	-1
1.8 V LVCMOS	1.71	1.8	1.89	-0.3	$0.35 \times V_{CCIO}$	$0.65 \times V_{CCIO}$	$V_{CCIO} + 0.3$	0.45	$V_{CCIO} - 0.45$	2	-2
1.5 V LVCMOS	1.425	1.5	1.575	-0.3	$0.35 \times V_{CCIO}$	$0.65 \times V_{CCIO}$	$V_{CCIO} + 0.3$	$0.25 \times V_{CCIO}$	$0.75 \times V_{CCIO}$	2	-2
1.2 V LVCMOS	1.14	1.2	1.26	-0.3	$0.35 \times V_{CCIO}$	$0.65 \times V_{CCIO}$	$V_{CCIO} + 0.3$	$0.25 \times V_{CCIO}$	$0.75 \times V_{CCIO}$	2	-2
3.0-V PCI	2.85	3	3.15	—	$0.3 \times V_{CCIO}$	$0.5 \times V_{CCIO}$	$V_{CCIO} + 0.3$	$0.1 \times V_{CCIO}$	$0.9 \times V_{CCIO}$	1.5	-0.5
3.0-V PCI-X	2.85	3	3.15	—	$0.35 \times V_{CCIO}$	$0.5 \times V_{CCIO}$	$V_{CCIO} + 0.3$	$0.1 \times V_{CCIO}$	$0.9 \times V_{CCIO}$	1.5	-0.5

**Table 1–23** lists the single-ended I/O standards for Arria II GZ devices.

**Table 1–23. Single-Ended I/O Standards for Arria II GZ Devices (Part 1 of 2)**

I/O Standard	$V_{CCIO}$ (V)			$V_{IL}$ (V)		$V_{IH}$ (V)		$V_{OL}$ (V)	$V_{OH}$ (V)	$I_{OL}$ (mA)	$I_{OH}$ (mA)
	Min	Typ	Max	Min	Max	Min	Max	Max	Min		
LVTTL	2.85	3	3.15	-0.3	0.8	1.7	3.6	0.4	2.4	2	-2
LVCMOS	2.85	3	3.15	-0.3	0.8	1.7	3.6	0.2	$V_{CCIO} - 0.2$	0.1	-0.1
2.5 V	2.375	2.5	2.625	-0.3	0.7	1.7	3.6	0.4	2	1	-1
1.8 V	1.71	1.8	1.89	-0.3	$0.35 \times V_{CCIO}$	$0.65 \times V_{CCIO}$	$V_{CCIO} + 0.3$	0.45	$V_{CCIO} - 0.45$	2	-2
1.5 V	1.425	1.5	1.575	-0.3	$0.35 \times V_{CCIO}$	$0.65 \times V_{CCIO}$	$V_{CCIO} + 0.3$	$0.25 \times V_{CCIO}$	$0.75 \times V_{CCIO}$	2	-2

## Switching Characteristics

This section provides performance characteristics of the Arria II GX and GZ core and periphery blocks for commercial grade devices. The following tables are considered final and are based on actual silicon characterization and testing. These numbers reflect the actual performance of the device under worst-case silicon process, voltage, and junction temperature conditions.

### Transceiver Performance Specifications

Table 1–34 lists the Arria II GX transceiver specifications.

**Table 1–34. Transceiver Specifications for Arria II GX Devices (Note 1) (Part 1 of 7)**

Symbol/ Description	Condition	I3			C4			C5 and I5			C6			Unit	
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	Min	Typ	Max		
<b>Reference Clock</b>															
Supported I/O Standards	1.2-V PCML, 1.5-V PCML, 2.5-V PCML, Differential LVPECL, LVDS, and HCSL														
Input frequency from REFCLK input pins	—	50	—	622.08	50	—	622.08	50	—	622.08	50	—	622.08	MHz	
Input frequency from PLD input	—	50	—	200	50	—	200	50	—	200	50	—	200	MHz	
Absolute $V_{MAX}$ for a REFCLK pin	—	—	—	2.2	—	—	2.2	—	—	2.2	—	—	2.2	V	
Absolute $V_{MIN}$ for a REFCLK pin	—	-0.3	—	—	-0.3	—	—	-0.3	—	—	-0.3	—	—	V	
Rise/fall time (2)	—	—	—	0.2	—	—	0.2	—	—	0.2	—	—	0.2	UI	
Duty cycle	—	45	—	55	45	—	55	45	—	55	45	—	55	%	
Peak-to-peak differential input voltage	—	200	—	2000	200	—	2000	200	—	2000	200	—	2000	mV	
Spread-spectrum modulating clock frequency	PCIe	30	—	33	30	—	33	30	—	33	30	—	33	kHz	

Table 1–34. Transceiver Specifications for Arria II GX Devices **(Note 1)** (Part 3 of 7)

Symbol/ Description	Condition	I3			C4			C5 and I5			C6			Unit
		Min	Typ	Max										
fixedclk clock frequency	PCIe Receiver Detect	—	125	—	—	125	—	—	125	—	—	125	—	MHz
reconfig_clk clock frequency	Dynamic reconfig. clock frequency	2.5/ 37.5 <i>(4)</i>	—	50	MHz									
Delta time between reconfig_clks <i>(5)</i>	—	—	—	2	—	—	2	—	—	2	—	—	2	ms
Transceiver block minimum power-down pulse width	—	—	1	—	—	1	—	—	1	—	—	1	—	μs
<b>Receiver</b>														
Supported I/O Standards	1.4-V PCML, 1.5-V PCML, 2.5-V PCML, 2.5-V PCML, LVPECL, and LVDS													
Data rate <i>(13)</i>	—	600	—	6375	600	—	3750	600	—	3750	600	—	3125	Mbps
Absolute V <sub>MAX</sub> for a receiver pin <i>(6)</i>	—	—	—	1.5	—	—	1.5	—	—	1.5	—	—	1.5	V
Absolute V <sub>MIN</sub> for a receiver pin	—	-0.4	—	—	-0.4	—	—	-0.4	—	—	-0.4	—	—	V
Maximum peak-to-peak differential input voltage V <sub>ID</sub> (diff p-p)	V <sub>ICM</sub> = 0.82 V setting	—	—	2.7	—	—	2.7	—	—	2.7	—	—	2.7	V
	V <sub>ICM</sub> = 1.1 V setting <i>(7)</i>	—	—	1.6	—	—	1.6	—	—	1.6	—	—	1.6	V

Figure 1–3 shows the differential receiver input waveform.

**Figure 1–3. Receiver Input Waveform**

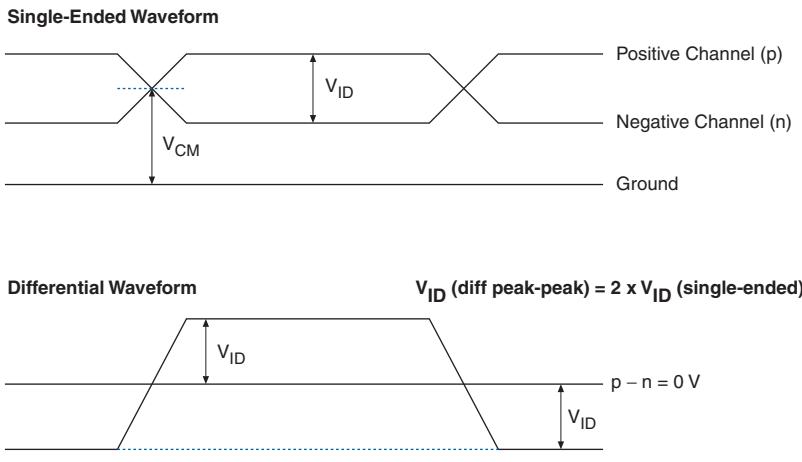


Figure 1–4 shows the transmitter output waveform.

**Figure 1–4. Transmitter Output Waveform**

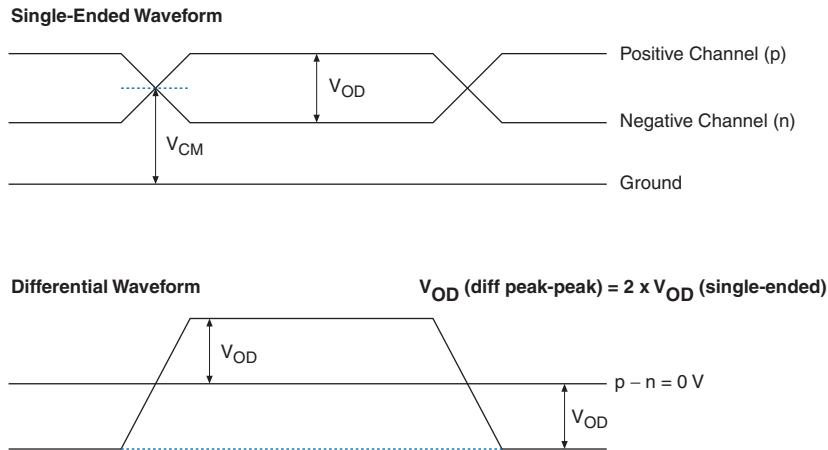


Table 1–36 lists the typical  $V_{OD}$  for TX term that equals 85  $\Omega$  for Arria II GZ devices.

**Table 1–36. Typical  $V_{OD}$  Setting, TX Term = 85  $\Omega$  for Arria II GZ Devices**

<b>Symbol</b>	<b><math>V_{OD}</math> Setting (mV)</b>							
	<b>0</b>	<b>1</b>	<b>2</b>	<b>3</b>	<b>4</b>	<b>5</b>	<b>6</b>	<b>7</b>
$V_{OD}$ differential peak-to-peak Typical (mV)	$170 \pm 20\%$	$340 \pm 20\%$	$510 \pm 20\%$	$595 \pm 20\%$	$680 \pm 20\%$	$765 \pm 20\%$	$850 \pm 20\%$	$1020 \pm 20\%$

Table 1–37 lists the typical  $V_{OD}$  for TX term that equals  $100\ \Omega$  for Arria II GX and GZ devices.

**Table 1–37. Typical  $V_{OD}$  Setting, TX Termination =  $100\ \Omega$  for Arria II Devices**

Quartus II Setting	$V_{OD}$ Setting (mV)
1	400
2	600
3 (Arria II GZ)	700
4	800
5	900
6	1000
7	1200

Table 1–38 lists the typical transmitter pre-emphasis levels in dB for the first post tap under the following conditions: low-frequency data pattern (five 1s and five 0s) at 6.375 Gbps. The levels listed in Table 1–38 are a representation of possible pre-emphasis levels under these specified conditions only; the pre-emphasis levels may change with data pattern and data rate.

To predict the pre-emphasis level for your specific data rate and pattern, run simulations using the Arria II GX HSSI HSPICE models.

**Table 1–38. Transmitter Pre-Emphasis Levels for Arria II GX Devices**

Arria II GX (Quartus II Software) First Post Tap Setting	Arria II GX (Quartus II Software) $V_{OD}$ Setting						
	1	2	4	5	6	7	Unit
0 (off)	0	0	0	0	0	0	—
1	0.7	0	0	0	0	0	dB
2	2.7	1.2	0.3	0	0	0	dB
3	4.9	2.4	1.2	0.8	0.5	0.2	dB
4	7.5	3.8	2.1	1.6	1.2	0.6	dB
5	—	5.3	3.1	2.4	1.8	1.1	dB
6	—	7	4.3	3.3	2.7	1.7	dB

**Table 1–40. Transceiver Block Jitter Specifications for Arria II GX Devices (*Note 1*) (Part 2 of 10)**

Symbol/ Description	Conditions	I3			C4			C5, I5			C6			Unit
		Min	Typ	Max										
Jitter tolerance at 2488.32 Mbps	Jitter frequency = 0.06 KHz Pattern = PRBS15	> 15			> 15			> 15			> 15			UI
	Jitter frequency = 100 KHz Pattern = PRBS15	> 1.5			> 1.5			> 1.5			> 1.5			UI
	Jitter frequency = 1 MHz Pattern = PRBS15	> 0.15			> 0.15			> 0.15			> 0.15			UI
	Jitter frequency = 10 MHz Pattern = PRBS15	> 0.15			> 0.15			> 0.15			> 0.15			UI
<b>XAU1 Transmit Jitter Generation (3)</b>														
Total jitter at 3.125 Gbps	Pattern = CJPAT	—	—	0.3	—	—	0.3	—	—	0.3	—	—	0.3	UI
Deterministic jitter at 3.125 Gbps	Pattern = CJPAT	—	—	0.17	—	—	0.17	—	—	0.17	—	—	0.17	UI
<b>XAU1 Receiver Jitter Tolerance (3)</b>														
Total jitter	—	> 0.65			> 0.65			> 0.65			> 0.65			UI
Deterministic jitter	—	> 0.37			> 0.37			> 0.37			> 0.37			UI
Peak-to-peak jitter	Jitter frequency = 22.1 KHz	> 8.5			> 8.5			> 8.5			> 8.5			UI
Peak-to-peak jitter	Jitter frequency = 1.875 MHz	> 0.1			> 0.1			> 0.1			> 0.1			UI
Peak-to-peak jitter	Jitter frequency = 20 MHz	> 0.1			> 0.1			> 0.1			> 0.1			UI
<b>PCIe Transmit Jitter Generation (4)</b>														
Total jitter at 2.5 Gbps (Gen1)	Compliance pattern	—	—	0.25	—	—	0.25	—	—	0.25	—	—	0.25	UI

**Table 1–40. Transceiver Block Jitter Specifications for Arria II GX Devices (*Note 1*) (Part 6 of 10)**

Symbol/ Description	Conditions	I3			C4			C5, I5			C6			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
Sinusoidal jitter tolerance (peak-to-peak)	Jitter frequency = 20 KHz  Data rate = 1.485 Gbps (HD) Pattern = 75% color bar	> 1			> 1			> 1			> 1			UI
	Jitter frequency = 100 KHz  Data rate = 1.485 Gbps (HD) Pattern = 75% color bar	> 0.2			> 0.2			> 0.2			> 0.2			UI
	Jitter frequency = 148.5 MHz  Data rate = 1.485 Gbps (HD) Pattern = 75% color bar	> 0.2			> 0.2			> 0.2			> 0.2			UI

**SATA Transmit Jitter Generation (10)**

Total jitter at 1.5 Gbps (G1)	Compliance pattern	—	—	0.55	—	—	0.55	—	—	0.55	—	—	0.55	UI
Deterministic jitter at 1.5 Gbps (G1)	Compliance pattern	—	—	0.35	—	—	0.35	—	—	0.35	—	—	0.35	UI
Total jitter at 3.0 Gbps (G2)	Compliance pattern	—	—	0.55	—	—	0.55	—	—	0.55	—	—	0.55	UI
Deterministic jitter at 3.0 Gbps (G2)	Compliance pattern	—	—	0.35	—	—	0.35	—	—	0.35	—	—	0.35	UI
Total jitter at 6.0 Gbps (G3)	Compliance pattern	—	—	0.52	—	—	—	—	—	—	—	—	—	UI
Random jitter at 6.0 Gbps (G3)	Compliance pattern	—	—	0.18	—	—	—	—	—	—	—	—	—	UI

**SATA Receiver Jitter Tolerance (10)**

Total jitter tolerance at 1.5 Gbps (G1)	Compliance pattern	> 0.65			> 0.65			> 0.65			> 0.65			UI
Deterministic jitter tolerance at 1.5 Gbps (G1)	Compliance pattern	> 0.35			> 0.35			> 0.35			> 0.35			UI
SSC modulation frequency at 1.5 Gbps (G1)	Compliance pattern	33			33			33			33			kHz

**Table 1–41. Transceiver Block Jitter Specifications for Arria II GZ Devices (Note 1), (2) (Part 4 of 7)**

Symbol/ Description	Conditions	–C3 and –I3			–C4 and –I4			Unit
		Min	Typ	Max	Min	Typ	Max	
<b>GIGE Receiver Jitter Tolerance (11)</b>								
Deterministic jitter tolerance (peak-to-peak)	Pattern = CJPAT			> 0.4			> 0.4	UI
Combined deterministic and random jitter tolerance (peak-to-peak)	Pattern = CJPAT			> 0.66			> 0.66	UI
<b>HiGig Transmit Jitter Generation</b>								
Deterministic jitter (peak-to-peak)	Data rate = 3.75 Gbps Pattern = CJPAT	—	—	0.17	—	—	—	UI
Total jitter (peak-to-peak)	Data rate = 3.75 Gbps Pattern = CJPAT	—	—	0.35	—	—	—	UI
<b>HiGig Receiver Jitter Tolerance</b>								
Deterministic jitter tolerance (peak-to-peak)	Data rate = 3.75 Gbps Pattern = CJPAT			> 0.37	—	—	—	UI
Combined deterministic and random jitter tolerance (peak-to-peak)	Data rate = 3.75 Gbps Pattern = CJPAT			> 0.65	—	—	—	UI
Sinusoidal jitter tolerance (peak-to-peak)	Jitter frequency = 22.1 KHz Data rate = 3.75 Gbps Pattern = CJPAT			> 8.5	—	—	—	UI
	Jitter frequency = 22.1 KHz Data rate = 3.75 Gbps Pattern = CJPAT			> 0.1	—	—	—	UI
	Jitter frequency = 22.1 KHz Data rate = 3.75 Gbps Pattern = CJPAT			> 0.1	—	—	—	UI
<b>(OIF) CEI Transmitter Jitter Generation</b>								
Total jitter (peak-to-peak)	Data rate = 6.375 Gbps Pattern = PRBS15 BER = $10^{-12}$	—	—	0.3	—	—	0.3	UI
<b>(OIF) CEI Receiver Jitter Tolerance</b>								
Deterministic jitter tolerance (peak-to-peak)	Data rate = 6.375 Gbps Pattern = PRBS31 BER = $10^{-12}$			> 0.675	—	—	—	UI
Combined deterministic and random jitter tolerance (peak-to-peak)	Data rate = 6.375 Gbps Pattern = PRBS31 BER = $10^{-12}$			> 0.988	—	—	—	UI

**Table 1–41. Transceiver Block Jitter Specifications for Arria II GZ Devices (Note 1), (2) (Part 5 of 7)**

Symbol/ Description	Conditions	–C3 and –I3			–C4 and –I4			Unit
		Min	Typ	Max	Min	Typ	Max	
Sinusoidal jitter tolerance (peak-to-peak)	Jitter Frequency = 38.2 KHz Data rate = 6.375 Gbps Pattern = PRBS31 BER = $10^{-12}$	> 0.5			—	—	—	UI
	Jitter Frequency = 3.82 MHz Data rate = 6.375 Gbps Pattern = PRBS31 BER = $10^{-12}$	> 0.05			—	—	—	UI
	Jitter Frequency = 20 MHz Data rate = 6.375 Gbps Pattern = PRBS31 BER = $10^{-12}$	> 0.05			—	—	—	UI
<b>SDI Transmitter Jitter Generation (12)</b>								
Alignment jitter (peak-to-peak)	Data rate = 1.485 Gbps (HD) Pattern = color bar Low-frequency roll-off = 100 KHz	0.2	—	—	0.2	—	—	UI
	Data rate = 2.97 Gbps (3G) Pattern = color bar Low-frequency roll-off = 100 KHz	0.3	—	—	0.3	—	—	UI
<b>SDI Receiver Jitter Tolerance (12)</b>								
Sinusoidal jitter tolerance (peak-to-peak)	Jitter frequency = 15 KHz Data rate = 2.97 Gbps (3G) Pattern = single line scramble color bar	> 2			> 2			UI
	Jitter frequency = 100 KHz Data rate = 2.97 Gbps (3G) Pattern = single line scramble color bar	> 0.3			> 0.3			UI
	Jitter frequency = 148.5 MHz Data rate = 2.97 Gbps (3G) Pattern = single line scramble color bar	> 0.3			> 0.3			UI
Sinusoidal jitter tolerance (peak-to-peak)	Jitter frequency = 20 KHz Data rate = 1.485 Gbps (HD) pattern = 75% color bar	> 1			> 1			UI
	Jitter frequency = 100 KHz Data rate = 1.485 Gbps (HD) Pattern = 75% color bar	> 0.2			> 0.2			UI
	Jitter frequency = 148.5 MHz Data rate = 1.485 Gbps (HD) Pattern = 75% color bar	> 0.2			> 0.2			UI
<b>SAS Transmit Jitter Generation (13)</b>								
Total jitter at 1.5 Gbps (G1)	Pattern = CJPAT	—	—	0.55	—	—	0.55	UI
Deterministic jitter at 1.5 Gbps (G1)	Pattern = CJPAT	—	—	0.35	—	—	0.35	UI
Total jitter at 3.0 Gbps (G2)	Pattern = CJPAT	—	—	0.55	—	—	0.55	UI

**Table 1–45. PLL Specifications for Arria II GZ Devices (Part 2 of 2)**

<b>Symbol</b>	<b>Parameter</b>	<b>Min</b>	<b>Typ</b>	<b>Max</b>	<b>Unit</b>
$t_{DLOCK}$	Time required to lock dynamically (after switchover or reconfiguring any non-post-scale counters/delays)	—	—	1	ms
$f_{CLBW}$	PLL closed-loop low bandwidth	—	0.3	—	MHz
	PLL closed-loop medium bandwidth	—	1.5	—	MHz
	PLL closed-loop high bandwidth (7)	—	4	—	MHz
$t_{PLL\_PSERR}$	Accuracy of PLL phase shift	—	—	$\pm 50$	ps
$t_{ARESET}$	Minimum pulse width on the <code>areset</code> signal	10	—	—	ns
$t_{INCCJ} \text{ (3), (4)}$	Input clock cycle to cycle jitter ( $F_{REF} \geq 100$ MHz)	—	—	0.15	UI (p-p)
	Input clock cycle to cycle jitter ( $F_{REF} < 100$ MHz)	—	—	$\pm 750$	ps (p-p)
$t_{OUTPJ\_DC} \text{ (5)}$	Period Jitter for dedicated clock output ( $F_{OUT} \geq 100$ MHz)	—	—	175	ps (p-p)
	Period Jitter for dedicated clock output ( $F_{OUT} < 100$ MHz)	—	—	17.5	mUI (p-p)
$t_{OUTCCJ\_DC} \text{ (5)}$	Cycle to Cycle Jitter for dedicated clock output ( $F_{OUT} \geq 100$ MHz)	—	—	175	ps (p-p)
	Cycle to Cycle Jitter for dedicated clock output ( $F_{OUT} < 100$ MHz)	—	—	17.5	mUI (p-p)
$t_{OUTPJ\_IO} \text{ (5), (8)}$	Period Jitter for clock output on regular I/O ( $F_{OUT} \geq 100$ MHz)	—	—	600	ps (p-p)
	Period Jitter for clock output on regular I/O ( $F_{OUT} < 100$ MHz)	—	—	60	mUI (p-p)
$t_{OUTCCJ\_IO} \text{ (5), (8)}$	Cycle to Cycle Jitter for clock output on regular I/O ( $F_{OUT} \geq 100$ MHz)	—	—	600	ps (p-p)
	Cycle to Cycle Jitter for clock output on regular I/O ( $F_{OUT} < 100$ MHz)	—	—	60	mUI (p-p)
$t_{CASC\_OUTPJ\_DC} \text{ (5), (6)}$	Period Jitter for dedicated clock output in cascaded PLLs ( $F_{OUT} \geq 100$ MHz)	—	—	250	ps (p-p)
	Period Jitter for dedicated clock output in cascaded PLLs ( $F_{OUT} < 100$ MHz)	—	—	25	mUI (p-p)
$f_{DRIFT}$	Frequency drift after PFDENA is disabled for duration of 100 us	—	—	$\pm 10$	%

**Notes to Table 1–45:**

- (1) This specification is limited in the Quartus II software by the I/O maximum frequency. The maximum I/O frequency is different for each I/O standard.
- (2) This specification is limited by the lower of the two: I/O  $F_{MAX}$  or  $F_{OUT}$  of the PLL.
- (3) A high input jitter directly affects the PLL output jitter. To have low PLL output clock jitter, you must provide a clean clock source that is less than 120 ps.
- (4)  $F_{REF}$  is  $f_{IN/N}$  when  $N = 1$ .
- (5) Peak-to-peak jitter with a probability level of  $10^{-12}$  (14 sigma, 99.9999999974404% confidence level). The output jitter specification applies to the intrinsic jitter of the PLL, when an input jitter of 30 ps is applied. The external memory interface clock output jitter specifications use a different measurement method and are available in [Table 1–64 on page 1–71](#).
- (6) The cascaded PLL specification is only applicable with the following condition:
  - a. Upstream PLL:  $0.59$  MHz  $\leq$  Upstream PLL BW  $< 1$  MHz
  - b. Downstream PLL: Downstream PLL BW  $> 2$  MHz
- (7) High bandwidth PLL settings are not supported in external feedback mode.
- (8) External memory interface clock output jitter specifications use a different measurement method, which is available in [Table 1–63 on page 1–71](#).

## DSP Block Specifications

Table 1–46 lists the DSP block performance specifications for Arria II GX devices.

**Table 1–46. DSP Block Performance Specifications for Arria II GX Devices (Note 1)**

Mode	Resources Used	Performance				Unit
	Number of Multipliers	C4	I3	C5,I5	C6	
9 × 9-bit multiplier	1	380	310	300	250	MHz
12 × 12-bit multiplier	1	380	310	300	250	MHz
18 × 18-bit multiplier	1	380	310	300	250	MHz
36 × 36-bit multiplier	1	350	270	270	220	MHz
18 × 36-bit high-precision multiplier adder mode	1	350	270	270	220	MHz
18 × 18-bit multiply accumulator	4	380	310	300	250	MHz
18 × 18-bit multiply adder	4	380	310	300	250	MHz
18 × 18-bit multiply adder-signed full precision	2	380	310	300	250	MHz
18 × 18-bit multiply adder with loopback (2)	2	275	220	220	180	MHz
36-bit shift (32-bit data)	1	350	270	270	220	MHz
Double mode	1	350	270	270	220	MHz

**Notes to Table 1–46:**

- (1) Maximum is for a fully-pipelined block with **Round** and **Saturation** disabled.
- (2) Maximum is for loopback input registers disabled, **Round** and **Saturation** disabled, pipeline and output registers enabled.

Table 1–47 lists the DSP block performance specifications for Arria II GZ devices.

**Table 1–47. DSP Block Performance Specifications for Arria II GZ Devices (Note 1) (Part 1 of 2)**

Mode	Resources Used	Performance		Unit
	Number of Multipliers	-3	-4	
9 × 9-bit multiplier	1	460	400	MHz
12 × 12-bit multiplier	1	500	440	MHz
18 × 18-bit multiplier	1	550	480	MHz
36 × 36-bit multiplier	1	440	380	MHz
18 × 18-bit multiply accumulator	4	440	380	MHz
18 × 18-bit multiply adder	4	470	410	MHz
18 × 18-bit multiply adder-signed full precision	2	450	390	MHz
18 × 18-bit multiply adder with loopback (2)	2	350	310	MHz
36-bit shift (32-bit data)	1	440	380	MHz

**Table 1–47. DSP Block Performance Specifications for Arria II GZ Devices (*Note 1*) (Part 2 of 2)**

Mode	Resources Used	Performance			Unit
	Number of Multipliers	-3	-4		
Double mode	1	440	380	MHz	

**Notes to Table 1–47:**

- (1) Maximum is for fully pipelined block with **Round** and **Saturation** disabled.
- (2) Maximum for loopback input registers disabled, **Round** and **Saturation** disabled, and pipeline and output registers enabled.

**Embedded Memory Block Specifications**

Table 1–48 lists the embedded memory block specifications for Arria II GX devices.

**Table 1–48. Embedded Memory Block Performance Specifications for Arria II GX Devices**

Memory	Mode	Resources Used		Performance				Unit
		ALUTs	Embedded Memory	I3	C4	C5,I5	C6	
Memory Logic Array Block (MLAB)	Single port 64 × 10	0	1	450	500	450	378	MHz
	Simple dual-port 32 × 20 single clock	0	1	270	500	450	378	MHz
	Simple dual-port 64 × 10 single clock	0	1	428	500	450	378	MHz
M9K Block	Single-port 256 × 36	0	1	360	400	360	310	MHz
	Single-port 256 × 36, with the <b>read-during-write</b> option set to <b>Old Data</b>	0	1	250	280	250	210	MHz
	Simple dual-port 256 × 36 single CLK	0	1	360	400	360	310	MHz
	Single-port 256 × 36 single CLK, with the <b>read-during-write</b> option set to <b>Old Data</b>	0	1	250	280	250	210	MHz
	True dual port 512 × 18 single CLK	0	1	360	400	360	310	MHz
	True dual-port 512 × 18 single CLK, with the <b>read-during-write</b> option set to <b>Old Data</b>	0	1	250	280	250	210	MHz
	Min Pulse Width (clock high time)	—	—	900	850	950	1130	ps
	Min Pulse Width (clock low time)	—	—	730	690	770	920	ps

Table 1–49 lists the embedded memory block specifications for Arria II GZ devices.

**Table 1–49. Embedded Memory Block Performance Specifications for Arria II GZ Devices (Note 1)**

Memory	Mode	Resources Used		Performance			Unit
		ALUTs	TriMatrix Memory	C3	I3	C4	
MLAB (2)	Single port 64 × 10	0	1	500	500	450	450 MHz
	Simple dual-port 32 × 20	0	1	500	500	450	450 MHz
	Simple dual-port 64 × 10	0	1	500	500	450	450 MHz
	ROM 64 × 10	0	1	500	500	450	450 MHz
	ROM 32 × 20	0	1	500	500	450	450 MHz
M9K Block (2)	Single-port 256 × 36	0	1	540	540	475	475 MHz
	Simple dual-port 256 × 36	0	1	490	490	420	420 MHz
	Simple dual-port 256 × 36, with the read-during-write option set to <b>Old Data</b>	0	1	340	340	300	300 MHz
	True dual port 512 × 18	0	1	430	430	370	370 MHz
	True dual-port 512 × 18, with the read-during-write option set to <b>Old Data</b>	0	1	335	335	290	290 MHz
	ROM 1 Port	0	1	540	540	475	475 MHz
	ROM 2 Port	0	1	540	540	475	475 MHz
	Min Pulse Width (clock high time)	—	—	800	800	850	850 ps
M144K Block (2)	Min Pulse Width (clock low time)	—	—	625	625	690	690 ps
	Single-port 2K × 72	0	1	440	400	380	350 MHz
	Simple dual-port 2K × 72	0	1	435	375	385	325 MHz
	Simple dual-port 2K × 72, with the read-during-write option set to <b>Old Data</b>	0	1	240	225	205	200 MHz
	Simple dual-port 2K × 64 (with ECC)	0	1	300	295	255	250 MHz
	True dual-port 4K × 36	0	1	375	350	330	310 MHz
	True dual-port 4K × 36, with the read-during-write option set to <b>Old Data</b>	0	1	230	225	205	200 MHz
	ROM 1 Port	0	1	500	450	435	420 MHz
	ROM 2 Port	0	1	465	425	400	400 MHz
	Min Pulse Width (clock high time)	—	—	755	860	860	950 ps
	Min Pulse Width (clock low time)	—	—	625	690	690	690 ps

**Notes to Table 1–48:**

- (1) To achieve the maximum memory block performance, use a memory block clock that comes through global clock routing from an on-chip PLL set to 50% output duty cycle. Use the Quartus II software to report timing for this and other memory block clocking schemes.
- (2) When you use the error detection CRC feature, there is no degradation in  $F_{MAX}$ .

**Table 1–57. External Memory Interface Specifications for Arria II GX Devices (Part 2 of 2)**

Frequency Mode	Frequency Range (MHz)			Resolution (°)	DQS Delay Buffer Mode (1)	Number of Delay Chains
	C4	I3, C5, I5	C6			
5	270-410	270-380	270-320	36	High	10
6	320-450	320-410	320-370	45	High	8

**Note to Table 1–57:**

- (1) Low indicates a 6-bit DQS delay setting; high indicates a 5-bit DQS delay setting.

Table 1–58 lists the DLL frequency range specifications for Arria II GZ devices.

**Table 1–58. DLL Frequency Range Specifications for Arria II GZ Devices**

Frequency Mode	Frequency Range (MHz)		Available Phase Shift	DQS Delay Buffer Mode (1)	Number of Delay Chains
	-3	-4			
0	90-130	90-120	22.5°, 45°, 67.5°, 90°	Low	16
1	120-170	120-160	30°, 60°, 90°, 120°	Low	12
2	150-210	150-200	36°, 72°, 108°, 144°	Low	10
3	180-260	180-240	45°, 90°, 135°, 180°	Low	8
4	240-320	240-290	30°, 60°, 90°, 120°	High	12
5	290-380	290-360	36°, 72°, 108°, 144°	High	10
6	360-450	360-450	45°, 90°, 135°, 180°	High	8
7	470-630	470-590	60°, 120°, 180°, 240°	High	6

**Note to Table 1–58:**

- (1) Low indicates a 6-bit DQS delay setting; high indicates a 5-bit DQS delay setting.

Table 1–59 lists the DQS phase offset delay per stage for Arria II GX devices.

**Table 1–59. DQS Phase Offset Delay Per Setting for Arria II GX Devices (Note 1), (2), (3)**

Speed Grade	Min	Max	Unit
C4	7.0	13.0	ps
I3, C5, I5	7.0	15.0	ps
C6	8.5	18.0	ps

**Notes to Table 1–59:**

- (1) The valid settings for phase offset are -64 to +63 for frequency modes 0 to 3 and -32 to +31 for frequency modes 4 to 5.  
(2) The typical value equals the average of the minimum and maximum values.  
(3) The delay settings are linear.

## IOE Programmable Delay

Table 1–66 lists the delay associated with each supported IOE programmable delay chain for Arria II GX devices.

**Table 1–66. IOE Programmable Delay for Arria II GX Devices**

Parameter	Available Settings (1)	Minimum Offset (2)	Maximum Offset								Unit	
			Fast Model			Slow Model						
			I3	C4	I5	I3	C4	C5	I5	C6		
Output enable pin delay	7	0	0.413	0.442	0.413	0.814	0.713	0.796	0.801	0.873	ns	
Delay from output register to output pin	7	0	0.339	0.362	0.339	0.671	0.585	0.654	0.661	0.722	ns	
Input delay from pin to internal cell	52	0	1.494	1.607	1.494	2.895	2.520	2.733	2.775	2.944	ns	
Input delay from pin to input register	52	0	1.493	1.607	1.493	2.896	2.503	2.732	2.774	2.944	ns	
DQS bus to input register delay	4	0	0.074	0.076	0.074	0.140	0.124	0.147	0.147	0.167	ns	

**Notes to Table 1–66:**

- (1) The available setting for every delay chain starts with zero and ends with the specified maximum number of settings.
- (2) The minimum offset represented in the table does not include intrinsic delay.

Table 1–67 lists the IOE programmable delay settings for Arria II GZ devices.

**Table 1–67. IOE Programmable Delay for Arria II GZ Devices**

Parameter	Available Settings (1)	Minimum Offset (2)	Maximum Offset						Unit	
			Fast Model		Slow Model					
			Industrial	Commercial	C3	I3	C4	I4		
D1	15	0	0.462	0.505	0.795	0.801	0.857	0.864	ns	
D2	7	0	0.234	0.232	0.372	0.371	0.407	0.405	ns	
D3	7	0	1.700	1.769	2.927	2.948	3.157	3.178	ns	
D4	15	0	0.508	0.554	0.882	0.889	0.952	0.959	ns	
D5	15	0	0.472	0.500	0.799	0.817	0.875	0.882	ns	
D6	6	0	0.186	0.195	0.319	0.321	0.345	0.347	ns	

**Notes to Table 1–67:**

- (1) You can set this value in the Quartus II software by selecting D1, D2, D3, D4, D5, and D6 in the Assignment Name column.
- (2) Minimum offset does not include the intrinsic delay.